TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74VCX2244FT, TC74VCX2244FK

Low-Voltage Octal Bus Buffer with 3.6-V Tolerant Inputs and Outputs

The TC74VCX2244 is a high-performance CMOS octal bus buffer. Designed for use in 1.8-V, 2.5-V or 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

It is also designed with overvoltage tolerant inputs and outputs up to $3.6\ V\!.$

This device is non-inverting 3-state buffer having four active-low output enables. When the \overline{OE} input is high, the outputs are in a high-impedance state. This device is designed to be used with 3-state memory address drivers, etc. The $26\text{-}\Omega$ series resistor helps reducing output overshoot and undershoot without external resistor.

All inputs are equipped with protection circuits against static discharge.

Features

- 26-Ω series resistors on outputs.
- Low-voltage operation: VCC = 1.8 to 3.6 V
- High-speed operation: $t_{pd} = 4.4 \text{ ns (max) (VCC} = 3.0 \text{ to } 3.6 \text{ V)}$

: $t_{pd} = 5.6 \text{ ns (max) (V}_{CC} = 2.3 \text{ to } 2.7 \text{ V})$

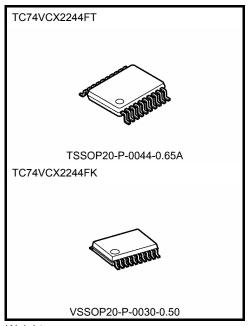
: $t_{pd} = 9.8 \text{ ns (max) (VCC} = 1.8 \text{ V)}$

• Output current: $I_{OH}/I_{OL} = \pm 12 \text{ mA (min)} (V_{CC} = 3.0 \text{ V})$

 $: I_{OH}/I_{OL} = \pm 8 \text{ mA (min) (V}_{CC} = 2.3 \text{ V)}$

 $: I_{OH}/I_{OL} = \pm 4 \text{ mA (min) (V}_{CC} = 1.8 \text{ V)}$

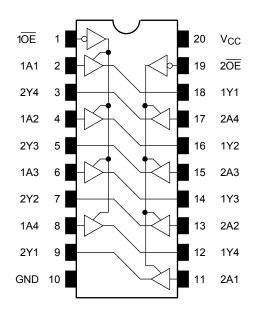
- Latch-up performance: -300 mA
- ESD performance: Machine model $\geq \pm 200 \text{ V}$ Human body model $\geq \pm 2000 \text{ V}$
- Package: TSSOP and VSSOP (US)
- 3.6-V tolerant function and power-down protection provided on all inputs and outputs



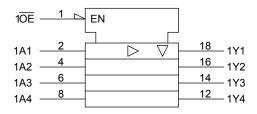
Weight

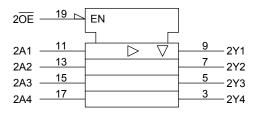
TSSOP20-P-0044-0.65A : 0.08 g (typ.) VSSOP20-P-0030-0.50 : 0.03 g (typ.)

Pin Assignment (top view)



IEC Logic Symbol





Truth Table

Inp	Outputs	
ŌĒ	An	Outputs
L	L	L
L	Н	Н
Н	Х	Z

X: Don't care

Z: High impedance



Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Power supply voltage	V _{CC}	-0.5 to 4.6	V
DC input voltage	V _{IN}	-0.5 to 4.6	V
		-0.5 to 4.6 (Note 2)	
DC output voltage	V _{OUT}	-0.5 to V _{CC} + 0.5	V
		(Note 3)	
Input diode current	I _{IK}	-50	mA
Output diode current	lok	±50 (Note 4)	mA
DC output current	Гоит	±50	mA
Power dissipation	P _D	180	mW
DC V _{CC} /ground current	I _{CC} /I _{GND}	±100	mA
Storage temperature	T _{stg}	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: OFF state

Note 3: High or low state. IOUT absolute maximum rating must be observed.

Note 4: $V_{OUT} < GND, V_{OUT} > V_{CC}$

Operating Ranges (Note 1)

Characteristics	Symbol	Rating	Unit
Power supply voltage	V _{CC}	1.8 to 3.6	V
Tower supply voltage	VCC	1.2 to 3.6 (Note 2)	V
Input voltage	V _{IN}	-0.3 to 3.6	V
Output voltage	Vout	0 to 3.6 (Note 3)	V
Output voltage	VOU1	0 to V _{CC} (Note 4)	V
		±12 (Note 5)	
Output current	I _{OH} /I _{OL}	±8 (Note 6)	mA
		±4 (Note 7)	
Operating temperature	T _{opr}	-40 to 85	°C
Input rise and fall time	dt/dv	0 to 10 (Note 8)	ns/V

Note 1: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs must be tied to either VCC or GND.

Note 2: Data retention only

Note 3: OFF state

Note 4: High or low state

Note 5: $V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$

Note 6: $V_{CC} = 2.3 \text{ to } 2.7 \text{ V}$

Note 7: $V_{CC} = 1.8 \text{ V}$

Note 8: $V_{IN} = 0.8$ to 2.0 V, $V_{CC} = 3.0$ V



Electrical Characteristics

DC Characteristics (Ta = -40 to 85° C, $2.7 \text{ V} < \text{V}_{\text{CC}} \le 3.6 \text{ V})$

Characteristics		Symbol	Test Condition			Min	Max	Unit
Input voltage	H-level	V _{IH}		_	2.7 to 3.6	2.0	_	V
input voltage	L-level	V _{IL}		_	2.7 to 3.6	_	0.8	•
				$I_{OH} = -100 \mu A$	2.7 to 3.6	V _{CC} - 0.2		
	H-level	VoH	V _{IN} = V _{IH} or V _{IL}	$I_{OH} = -6 \text{ mA}$	2.7	2.2	_	
				$I_{OH} = -8 \text{ mA}$	3.0	2.4	_	
Output voltage				$I_{OH} = -12 \text{ mA}$	3.0	2.2	_	V
				I _{OL} = 100 μA	2.7 to 3.6	_	0.2	
	L-level	Vai	V _{IN} = V _{IH} or V _{II}	I _{OL} = 6 mA	2.7	_	0.4	
	L-level V(V _{OL}	AIM = AIH OL AIT	I _{OL} = 8 mA	3.0	_	0.55	
				I _{OL} = 12 mA	3.0	_	0.8	
Input leakage current		I _{IN}	V _{IN} = 0 to 3.6 V		2.7 to 3.6	_	±5.0	μΑ
2 state subsut OFF sta	4	loz	V _{IN} = V _{IH} or V _{IL}		0.745.0.0		140.0	۸
3-state output OFF sta	3-state output OFF state current		$V_{OUT} = 0$ to 3.6 V		2.7 to 3.6	_	±10.0	μА
Power-off leakage current		l _{OFF}	V_{IN} , $V_{OUT} = 0$ to 3.6	V	0	_	10.0	μΑ
0		laa	V _{IN} = V _{CC} or GND		2.7 to 3.6	_	20.0	
Quiescent supply curre	51 IL	ICC	$V_{CC} \le (V_{IN}, V_{OUT}) \le$	3.6 V	2.7 to 3.6	_	±20.0	μΑ
Increase in I _{CC} per inp	out	Δlcc	$V_{IH} = V_{CC} - 0.6 V$		2.7 to 3.6	_	750	

DC Characteristics (Ta = -40 to 85°C, 2.3 V \leq V_{CC} \leq 2.7 V)

Characte	ristics	Symbol	Test	Condition	V _{CC} (V)	Min	Max	Unit		
	H-level	V _{IH}		_	2.3 to 2.7	1.6	_	.,		
Input voltage	L-level	V _{IL}		_	2.3 to 2.7	_	0.7	V		
				I _{OH} = -100 μA	2.3 to 2.7	V _{CC} - 0.2	_			
	H-level	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -4 mA	2.3	2.0	_			
				$I_{OH} = -6 \text{ mA}$	2.3	1.8	_	V		
Output voltage				$I_{OH} = -8 \text{ mA}$	2.3	1.7	_			
		V _{OL}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OL} = 100 \mu A$	2.3 to 2.7	_	0.2			
	L-level			I _{OL} = 6 mA	2.3	_	0.4			
				I _{OL} = 8 mA	2.3	_	0.6			
Input leakage curre	nt	I _{IN}	V _{IN} = 0 to 3.6 V		2.3 to 2.7	_	±5.0	μА		
3-state output OFF state current		VIN = VIH or VIL		output OFF state current I _{OZ}		$V_{IN} = V_{IH}$ or V_{IL} $V_{OUT} = 0$ to 3.6 V			±10.0	μА
		-02	$V_{OUT} = 0$ to 3.6 V							
Power-off leakage of	current	l _{OFF}	V_{IN} , $V_{OUT} = 0$ to 3.6	8 V	0		10.0	μΑ		
Quiescent supply cu	ırrent	loo	$V_{IN} = V_{CC}$ or GND	$V_{IN} = V_{CC}$ or GND			20.0	μА		
Quiescent supply co	ai i Gill	Icc	$V_{CC} \le (V_{IN}, V_{OUT}) \le 3.6 \text{ V}$		2.3 to 2.7	_	±20.0	μΑ		



DC Characteristics (Ta = -40 to 85°C, 1.8 V \leq V_{CC} < 2.3 V)

Characteristics		Symbol	Test Condition		V _{CC} (V)	Min	Max	Unit
Input voltage	H-level	V _{IH}	-	_	1.8 to 2.3	0.7 × V _{CC}	_	V
input voltage	L-level	V _{IL}	-	_	1.8 to 2.3		0.2 × V _{CC}	V
	H-level	Voh	V _{OH} V _{IN} = V _{IH} or V _{II}	I _{OH} = -100 μA	1.8	V _{CC} - 0.2		V
Output voltage				$I_{OH} = -4 \text{ mA}$	1.8	1.4		
	L-level	V _{OL}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OL} = 100 \mu A$	1.8		0.2	
	L-IEVEI			$I_{OL} = 4 \text{ mA}$	1.8		0.3	
Input leakage current		I _{IN}	V _{IN} = 0 to 3.6 V		1.8		±5.0	μΑ
3-state output OFF state current		I _{OZ}	$V_{IN} = V_{IH}$ or V_{IL} $V_{OUT} = 0$ to 3.6 V		1.8	_	±10.0	μА
Power-off leakage current I_{OFF} V_{IN} , $V_{OUT} = 0$ to 3.6 V		1	0	_	10.0	μΑ		
Ouissant summit summer			$V_{IN} = V_{CC}$ or GND		1.8	_	20.0	μА
Quiescent supply curre	iii	Icc	$V_{CC} \le (V_{IN}, V_{OUT}) \le 3$	3.6 V	1.8	_	±20.0	μΑ

AC Characteristics (Ta = -40 to 85°C, input: $t_r = t_f = 2.0$ ns, $C_L = 30$ pF, $R_L = 500~\Omega$) (Note 1)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Min	Max	Unit
			1.8	1.5	9.8	
Propagation delay time	t _{pLH}	Figure 1, Figure 2	2.5 ± 0.2	0.8	5.6	ns
	t _{pHL}		3.3 ± 0.3	0.6	4.4	
	+		1.8	1.5	9.8	
3-state output enable time	t _{pZL} t _{pZH}	Figure 1, Figure 3	2.5 ± 0.2	8.0	6.5	ns
			3.3 ± 0.3	0.6	5.0	
	t _{pLZ}		1.8	1.5	7.0	
3-state output disable time		Figure 1, Figure 3	2.5 ± 0.2	0.8	3.9	ns
			3.3 ± 0.3	0.6	3.6	
Output to output skew	.	(Note 2)	1.8	_	0.5	
	t _{osLH}		2.5 ± 0.2	_	0.5	ns
	tosHL		3.3 ± 0.3		0.5	

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Note 1: For $C_L = 50$ pF, add approximately 300 ps to the AC maximum specification.

Note 2: Parameter guaranteed by design. $(t_{OSLH} = |t_{DLHm} - t_{DLHn}|, \, t_{OSHL} = |t_{DHLm} - t_{DHLn}|)$

Dynamic Switching Characteristics (Ta = 25°C, input: $t_r = t_f = 2.0$ ns, $C_L = 30$ pF)

Characteristics	Symbol	Test Condition			Тур.	Unit
Characteristics	Symbol	rest condition	١	V _{CC} (V)	τyp.	5
		$V_{IH} = 1.8 \text{ V}, V_{IL} = 0 \text{ V}$ (N	te)	1.8	0.15	
Quiet output maximum dynamic V _{OL}	V _{OLP}	$V_{IH} = 2.5 \text{ V}, V_{IL} = 0 \text{ V}$ (N	te)	2.5	0.25	V
		$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$ (N	te)	3.3	0.35	
	V _{OLV}	$V_{IH} = 1.8 \text{ V}, V_{IL} = 0 \text{ V}$ (N	te)	1.8	-0.15	
Quiet output minimum dynamic V _{OL}		$V_{IH} = 2.5 \text{ V}, V_{IL} = 0 \text{ V}$ (N	te)	2.5	-0.25	V
		$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$ (N	te)	3.3	-0.35	
Quiet output minimum dynamic VOH	V _{OHV}	$V_{IH} = 1.8 \text{ V}, V_{IL} = 0 \text{ V}$ (N	te)	1.8	1.55	
		$V_{IH} = 2.5 \text{ V}, V_{IL} = 0 \text{ V}$ (N	ite)	2.5	2.05	V
···		$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$ (N	ite)	3.3	2.65	

Note: Parameter guaranteed by design.

Capacitive Characteristics (Ta = 25°C)

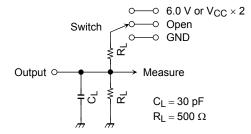
Characteristics	Symbol Test Condition			Тур.	Unit
Characteristics	Syllibol	rest Condition	V _{CC} (V)	ī yp.	Offic
Input capacitance	C _{IN}	_	1.8, 2.5, 3.3	6	pF
Output capacitance	CO	_	1.8, 2.5, 3.3	7	pF
Power dissipation capacitance	C _{PD}	f _{IN} = 10 MHz (Note)	1.8, 2.5, 3.3	20	pF

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 \text{ (per bit)}$

AC Test Circuit



Parameter	Switch			
t _{pLH} , t _{pHL}	Open			
t _{pLZ} , t _{pZL}	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$			
t _{pHZ} , t _{pZH}	GND			

Figure 1

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AC Waveform

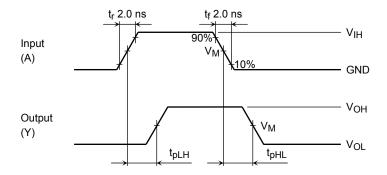


Figure 2 t_{pLH}, t_{pHL}

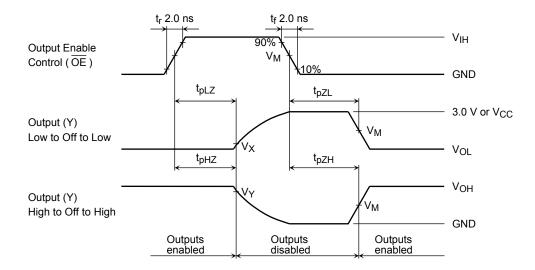


Figure 3 t_{pLZ} , t_{pHZ} , t_{pZL} , t_{pZH}

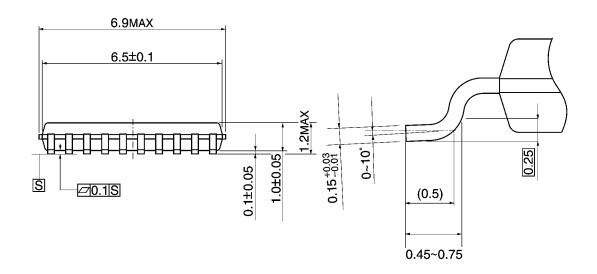
Symbol	Vcc							
Symbol	$3.3\pm0.3~\textrm{V}$	$2.5\pm0.2\textrm{V}$	1.8 V					
V _{IH}	2.7 V	V _{CC}	V _{CC}					
V _M	1.5 V	V _{CC} /2	V _{CC} /2					
VX	V _{OL} + 0.3 V	V _{OL} + 0.15 V	V _{OL} + 0.15 V					
VY	V _{OH} – 0.3 V	V _{OH} – 0.15 V	V _{OH} – 0.15 V					

Package Dimensions

TSSOP20-P-0044-0.65A

Unit: mm

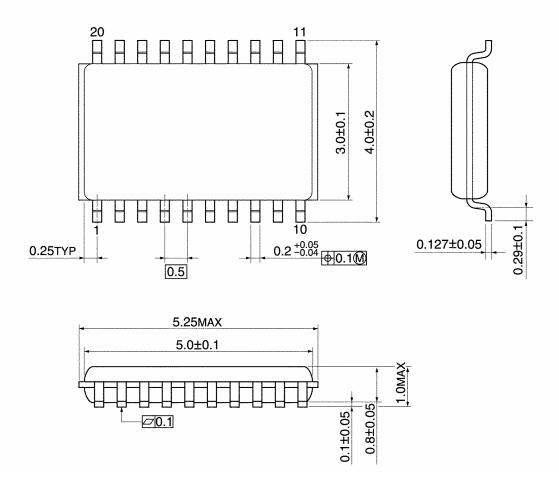
20
11
10
0.325TYP
0.65
0.22^{+0.09}
0.00
0.13
00



Weight: 0.08 g (typ.)

Package Dimensions

VSSOP20-P-0030-0.50 Unit: mm



Weight: 0.03 g (typ.)

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20070701-EN GENERAL

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